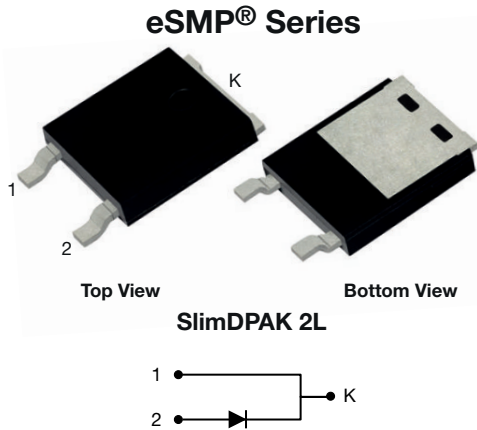


## Surface-Mount ESD Capability Rectifier



### FEATURES

- Creepage and clearance distance 2.8 mm minimum
- Very low profile - typical height of 1.3 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

AUTOMOTIVE  
GRADE  
Available



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive on board charger applications.

### MECHANICAL DATA

**Case:** SlimDPAK 2L

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant  
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** as marked

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	10 A
$V_{RRM}$	400 V, 600 V
$I_{FSM}$	125 A
$V_F$ at $I_F = 10$ A ( $T_J = 125$ °C)	0.93 V
$T_J$ max.	175 °C
Package	SlimDPAK 2L
Circuit configurations	Single

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)				
PARAMETER	SYMBOL	SE100PWTG	SE100PWTJ	UNIT
Device marking code		SE100PWTG	SE100PWTJ	
Maximum repetitive peak reverse voltage	$V_{RRM}$	400	600	V
Maximum average forward rectified current (Fig. 1)	$I_{F(AV)}^{(1)}$	10		A
	$I_{F(AV)}^{(2)}$	2.7		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	125		A
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175		°C

#### Notes

- (1) With infinite heatsink  
(2) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Maximum Instantaneous forward voltage	$I_F = 5.0\text{ A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.93	-	V
	$I_F = 10.0\text{ A}$			1.01	1.14	
	$I_F = 5.0\text{ A}$	$T_J = 125\text{ }^\circ\text{C}$		0.82	-	
	$I_F = 10.0\text{ A}$			0.93	1.09	
Reverse current	Rated $V_R$	$T_J = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	20	$\mu\text{A}$
		$T_J = 125\text{ }^\circ\text{C}$		25	150	
Typical reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$		$t_{rr}$	2600	-	ns
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	78	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: pulse width  $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	75	94	$^\circ\text{C/W}$
	$R_{\theta JM}^{(3)}$	2.2	2.8	

**Notes**

- (1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
(2) Thermal resistance junction to ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint  
(3) Thermal resistance junction-to-mount to follow JEDEC® 51-14 transient dual interface test method (TDIM)

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}, R = 1.5\text{ k}\Omega$	$V_C$	H3B	$> 8\text{ kV}$

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE100PWTJ-M3/I	0.185	I	4500	13" diameter plastic tape and reel
SE100PWTJHM3/I <sup>(1)</sup>	0.185	I	4500	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified



### RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

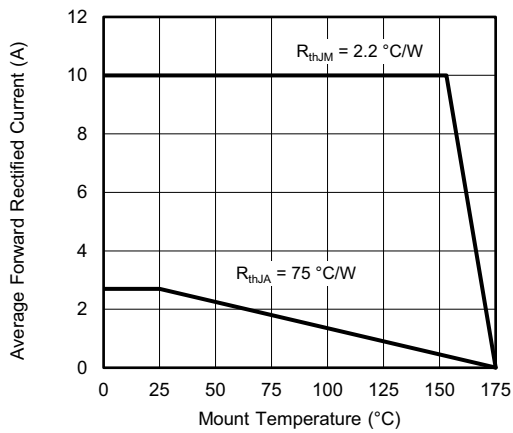


Fig. 1 - Maximum Forward Current Derating Curve

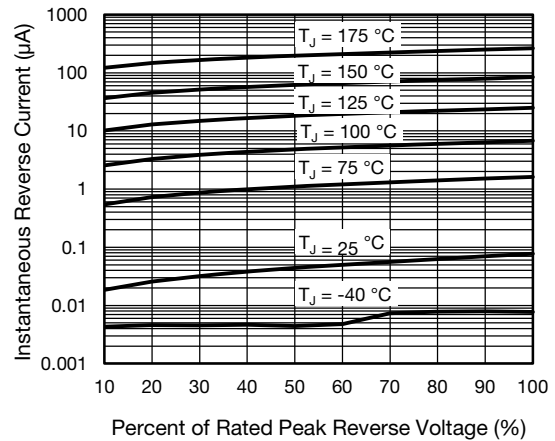


Fig. 4 - Typical Reverse Leakage Characteristics

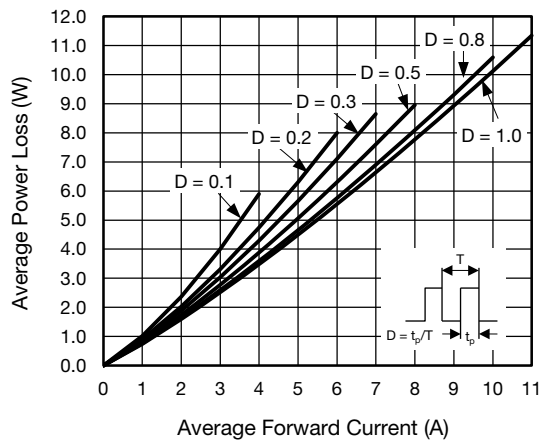


Fig. 2 - Forward Power Loss Characteristics

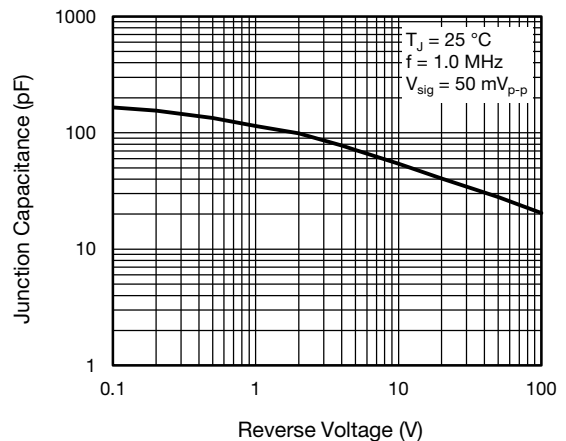


Fig. 5 - Typical Junction Capacitance

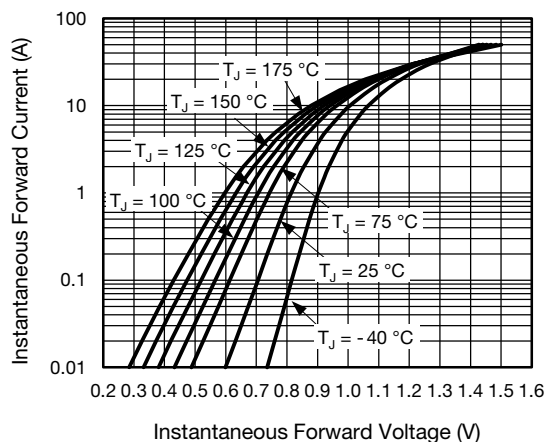


Fig. 3 - Typical Instantaneous Forward Characteristics

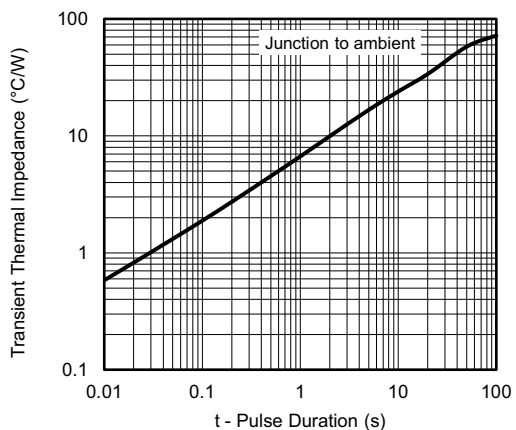
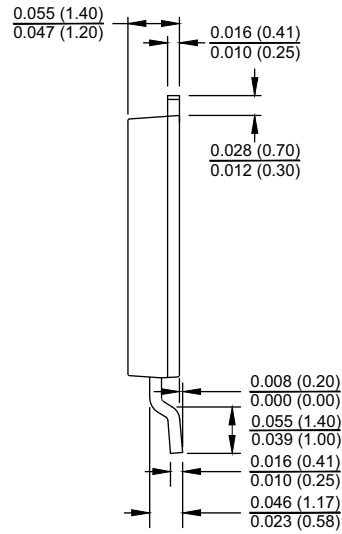
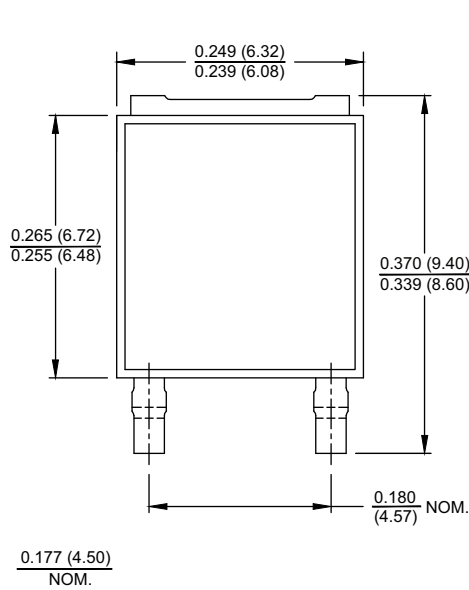


Fig. 6 - Typical Transient Thermal Impedance

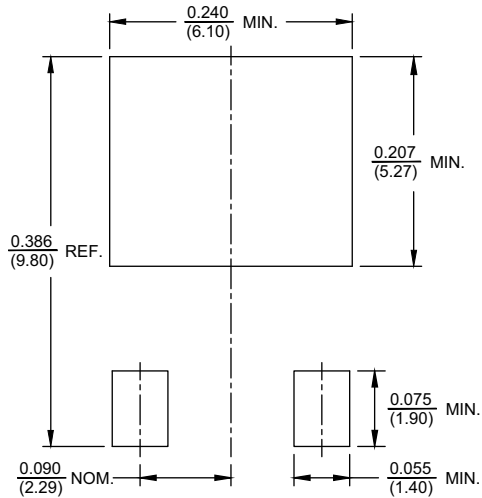
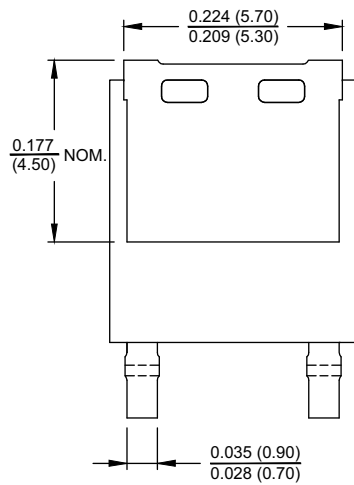


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimDPAK 2L



Mounting Pad Layout



Note

- The suggested mounting pad layout is provided for reference only, as actual pad layouts may vary depending on application



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.